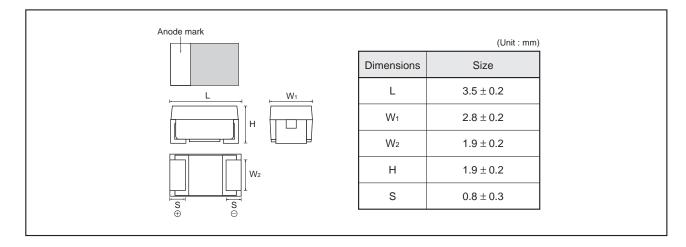
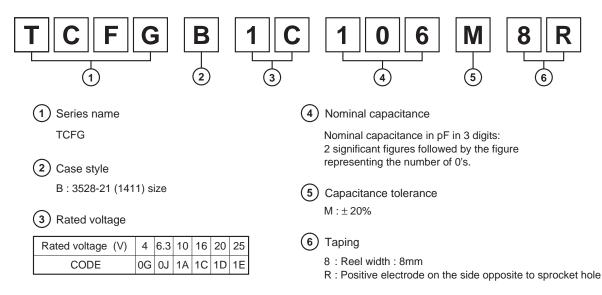
Features

- 1) Open structure built in for superior flame retardance characteristics.
- 2) Advanced wire bonding technology enable to make compact packages.
- 3) Eco-friendly halogen-free products.
- 4) Screening by thermal shock.

Dimensions



Part No. Explanation



*This specification has possibility of charge, due to underdevelopment product.

Rated table

Capacitance		Rated voltage (V.DC)											
(μF)	4	6.3	10	16	20	25							
3.3 (335)				В	☆B	В							
4.7 (475)				В	В	В							
10 (106)				В	☆B								
15 (156)				В									
22 (226)			В	В									
33 (336)			В	В									
47 (476)			В										
100 (107)	В	В	В										
150 (157)	В	В	В										
220 (227)	В	В											
Remark) Case siz	Remark) Case size codes (B) in the above show products line-up.												

Marking

The indications listed below should be given on the surface of a capacitor.

- (1) Polarity : The polarity should be shown by
 bar. (on the anode side)
- (2) Rated DC voltage : A voltage code is shown as below table.
- (3) Capacitance : A capacitance code is shown as below table.

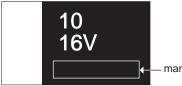
Visual typical example

voltage code and capacitance code are variable with parts number.

[B case]

- 10 16V EX.)
- $\overline{(1)}$ $\overline{(2)}$

(1) capacitance (2) voltage



manufacture code

Characteristics

Item		Performance					nance	Test conditions (based on JIS C5101-1 and JIS C5101-3)					
Operating Temperature		-55 °C to +125 °C							Voltage reduction when temperature exceeds +85°C				
Maximum operating temperature with no voltage derating		+85 °C											
Rated Voltage ((V.DC)	4	6.3	10	16	20	25		at 8	5°C			
Category Voltage (V.DC)		2.5	5 4 6.3 10 13 16 at 125°C										
Surge Voltage		5.0	0 8 13 20 26 32						at 85°C				
DC leakage current		Shall be satisfied the value on "Standard list"							As per 4.9 JIS C 5101-1 As per 4.5.1 JIS C 5101-3 Voltage : Rated voltage for 1 min				
Capacitance tol	erance	Shall be satisfied allowance range. ±20%						range.	As per 4.7 JIS C 5101-1 As per 4.5.2 JIS C 5101-3 Measuring frequency : 120±12Hz Measuring voltage : 0.5Vrms, +1.5V.DC Measuring circuit : DC Equivalent series circuit				
Tangent of loss angle (Df, tanδ)		Shall be satisfied the value on "Standard list"						on "Standard list"	As per 4.8 JIS C 5101-1 As per 4.5.3 JIS C 5101-3 Measuring frequency : 120±12Hz Measuring voltage : 0.5Vrms, +1.5V.DC Measuring circuit : DC Equivalent series circuit				
Impedance		Shall be satisfied the value on "Standard list"					on "Standard list"	As per 4.10 JIS C 5101-1 As per 4.5.4 JIS C 5101-3 Measuring frequency : 100±10kHz Measuring voltage : 0.5Vrms or less Measuring circuit : DC Equivalent series circuit					
Resistance to soldering heat		There should be no significant abnormality. The indications should be clear.						As p	As per 4.14 JIS C 5101-1 As per 4.6 JIS C 5101-3				
	L.C	TCFGB0G227M8R: Less than 150% of initial limitTCFGB0J227M8R: Less than 150% of initial limitTCFGB1A157M8R: Less than 150% of initial limitTCFGB1A107M8R: Less than 150% of initial limitTCFGB1E475M8R: Less than 150% of initial limitCFGB1E475M8R: Less than 150% of initial limitChers: Less than 150% of initial limit						s than 150% of initial limit s than 150% of initial limit s than 150% of initial limit s than 150% of initial limit	Dip in the solder bath Solder temp : $260\pm5^{\circ}$ C Duration : $5\pm0.5s$ Repetition : 1 After the specimens, leave it at room temperature for over 24h and then measure the sample.				
	⊿C / C	$\begin{array}{llllllllllllllllllllllllllllllllllll$					hin $\pm 15\%$ of initial value hin $\pm 15\%$ of initial value hin $\pm 15\%$ of initial value hin $\pm 10\%$ of initial value						
	tanð						as than 150% of initial limit as than 150% of initial limit						
Fail-Safe open u	unit actuation	Within 320°C – 20s							Dip in the solder bath Solder temp : 320±5°C				
Temperature cycle	Appearance	There should be no significant abnormality.									16 JIS C 5101-1 10 JIS C 5101-3		
Cycle	L.C TCFGB0G227M8/ TCFGB0J227M8F TCFGB1A157M8F TCFGB1A157M8F TCFGB1E475M8F Others	R R R R	: Les : Les : Les : Les	is than 150% of initial limit is than 200% of initial limit is than 200% of initial limit is than 200% of initial limit is than 150% of initial limit is than initial limit	Rep	oetitior		ycle : steps 1 to 4) Time 30±3min					
	⊿C/C	C/C TCFGB0G227M8R TCFGB0J227M8R TCFGB1A157M8R TCFGB1A107M8R		: Within ±15% of initial value		-	2	Room temp.	3min. or less				
			R R R	: Within $\pm 20\%$ of initial value : Within $\pm 20\%$ of initial value : Within $\pm 20\%$ of initial value			- 3 4	125±2°C Room temp.	30±3min 3min. or less				
	tanð	3.3 47 TCI TCI TCI TCI	to 33 to 15 FGB FGB FGB FGB	$\begin{array}{llllllllllllllllllllllllllllllllllll$		 After the specimens, leave it at room temperature for over 24h and then measure the sample. 							

lte	em	F	Performance	Test conditions (based on JIS C5101-1 and JIS C5101-3)				
Moisture resistance	Appearance	There should be no si The indications should		As per 4.22 JIS C 5101-1 As per 4.12 JIS C 5101-3				
	L.C	TCFGB0G227M8R TCFGB0J227M8R TCFGB1A157M8R TCFGB1A107M8R TCFGB1E475M8R Others	: Less than 150% of initial limit : Less than 200% of initial limit : Less than 200% of initial limit : Less than 200% of initial limit : Less than 150% of initial limit : Less than initial limit	After leaving the sample under such atmospheric condition that the temperature and humidity are 40±2°C and 90 to 95%RH, respectively, for 500±12h level it at room temperature for over 24h and then measure the sample.				
	⊿C / C	TCFGB0G227M8R TCFGB0J227M8R TCFGB1A157M8R TCFGB1A107M8R Others	: Within $\pm 15\%$ of initial value : Within $\pm 20\%$ of initial value					
	tanδ	3.3 to 33µF 47 to 150µF TCFGB0G227M8R TCFGB0J227M8R TCFGB1A157M8R TCFGB1A107M8R TCFGB1C336M8R	: Less than initial limit : Less than 150% of initial limit : Less than 150% of initial limit : Less than 200% of initial limit : Less than 200% of initial limit : Less than 200% of initial limit : Less than 150% of initial limit					
Temperature	Temp.	–55°C		As per 4.29 JIS C 5101-1				
Stability	⊿C / C	TCFGB0G227M8R TCFGB0J227M8R TCFGB1A157M8R TCFGB1A107M8R Others	: Within 0/-15% of initial value : Within 0/-30% of initial value : Within 0/-30% of initial value : Within 0/-30% of initial value : Within 0/-12% of initial value	As per 4.13 JIS C 5101-3				
	tanδ	Shall be satisfied the	value on Table5	-				
	L.C		_					
	Temp.	+85°C						
	⊿C / C	TCFGB0G227M8R TCFGB0J227M8R TCFGB1A157M8R TCFGB1A107M8R Others	: Within +12/0% of initial value : Within +15/0% of initial value : Within +15/0% of initial value : Within +15/0% of initial value : Within +10/0% of initial value					
	tanδ	Shall be satisfied the	value on Table5					
	L.C	Less than 1000% of ir	ntial limit					
	Temp.	+125°C						
	⊿C / C	TCFGB0J227M8R TCFGB1A157M8R TCFGB1A107M8R TCFGB1C336M8R Others	: Within +20/0% of initial value : Within +15/0% of initial value					
	tanδ	Shall be satisfied the	value on Table5					
	L.C	Less than 1250% of ir	nitial limit					
Surge Voltage	Appearance	There should be no si The indications should		As per 4.26 JIS C 5101-1 As per 4.14 JIS C 5101-3				
	L.C	TCFGB0G227M8R TCFGB0J227M8R TCFGB1A157M8R TCFGB1A107M8R TCFGB1E475M8R Others	: Less than 150% of initial limit : Less than 200% of initial limit : Less than 200% of initial limit : Less than 200% of initial limit : Less than 150% of initial limit : Less than initial limit	Apply the specified surge voltage via the serial resistance of 1kΩ every 5±0.5min. for 30±5 s. each time in the atmospheric condition of 85±2°C. Repeat this procedure 1,000 times. After the specimens, leave it at room temperature				
	⊿C / C	TCFGB0G227M8R TCFGB0J227M8R TCFGB1A157M8R TCFGB1A107M8R Others	: Within $\pm 15\%$ of initial value : Within $\pm 20\%$ of initial value : Within $\pm 10\%$ of initial value	for over 24h and then measure the sample.				
	tanδ	3.3 to 33µF 47 to 150µF TCFGB0G227M8R TCFGB0J227M8R TCFGB1A157M8R TCFGB1A107M8R TCFGB1C336M8R	: Less than initial limit : Less than 150% of initial limit : Less than 200% of initial limit : Less than 150% of initial limit					

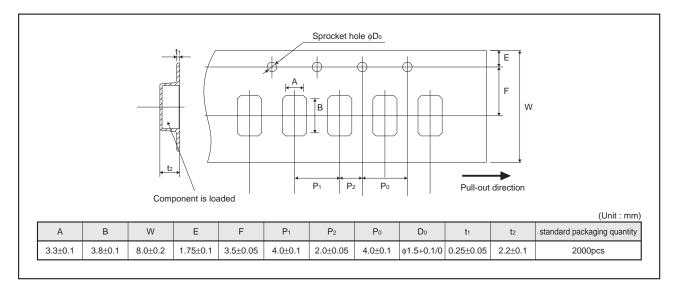
It	em	Performance	Test conditions (based on JIS C5101-1 and JIS C5101-3)					
Loading at High	Appearance	There should be no significant abnormality. The indications should be clear.	As per 4.23 JIS C 5101-1 As per 4.15 JIS C 5101-3					
temperature	L.C	TCFGB0G227M8R TCFGB0J227M8R: Less than 150% of initial limit : Less than 200% of initial limit : Less than 150% of initial limit	After applying the rated voltage for 2000+72/0h without discontinuation via the serial resistance of 3Ω or less at a temperature of $85\pm2^{\circ}$ C, leave the sample at room temperature/humidity for 1 to 2h and measure the value. After the specimens, leave it at room temperature for over 24h and then measure the sample.					
	⊿c / c	TCFGB0G227M8R: Within ±15% of initial valueTCFGB0J227M8R: Within ±20% of initial valueTCFGB1A157M8R: Within ±20% of initial valueTCFGB1A107M8R: Within ±20% of initial valueOthers: Within ±10% of initial value						
	tanδ	$\begin{array}{llllllllllllllllllllllllllllllllllll$						
Terminal	Capacitance	The measured value should be stable.	As per 4.35 JIS C 5101-1					
Strength	Appearance	There should be no significant abnormality.	As per 4.9 JIS C 5101-3 A force is applied to the terminal until it bends to 1mm and by a prescribed tool maintain the condition for 5s. (See the figure below.)					
			Thickness 1.6mm 45 + 45 + 45 + 1					
Adhesivenes	S	The terminal should not come off.	As per 4.34 JIS C 5101-1 As per 4.8 JIS C 5101-3 Apply force of 5N in the two directions shown in the figure below for 10±1s after mounting the terminal on a circuit board.					
			Apply force a circuit board					
Dimensions		Be based on "External dimensions"	Measure using a caliper of JIS B 7505 Class 2 or higher grade.					
Resistance to solvents		The indication should be clear.	As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.					
Solderability		3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.	As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed = 25 ± 2.5 mm/s Pre-treatment (accelerated aging) : Leave the sample on the boiling distilled water for 1h. Solder temp.: $245\pm5^{\circ}$ C Duration : 3 ± 0.5 s Solder : M705 Flux : Rosin 25%, IPA 75%					
/ibration	Capacitance	Measure value should not fluctuate during the measurement.	As per 4.17 JIS C 5101-1 Frequency : 10 to 55 to 10Hz/min. Amplitude : 1.5mm Time : 2h each in X and Y directions Mounting : The terminal is soldered on a print circuit board.					
	Appearance	There should be no significant abnormality.						

•Standard products list

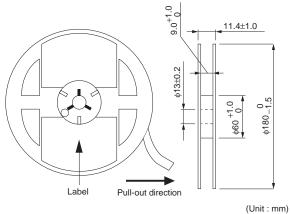
Part No.	Rated voltage 85°C	Category voltage 125°C	Surge voltage 85°C	Cap. 120Hz	Tolerance	Leakage current 25°C		Df 120Hz (%)		Impedance 100kHz
	(V)	(V)	(V)	(μF)	(%)	1WV.60s (μΑ)	–55°C	25°C 85°C	125°C	(Ω)
TCFG B 0G 107 M8R	4	2.5	5	100	± 20	4.0	30	12	16	1.6
TCFG B 0G 157 M8R	4	2.5	5	150	± 20	6.3	34	18	22	1.3
TCFG B 0G 227 M8R	4	2.5	5	220	± 20	8.8	40	20	30	1.3
TCFG B 0J 107 M8R	6.3	4	8	100	± 20	6.3	30	12	16	1.5
TCFG B 0J 157 M8R	6.3	4	8	150	± 20	9.5	34	18	22	1.5
TCFG B 0J 227 M8R	6.3	4	8	220	± 20	70	60	30	45	1.3
TCFG B 1A 226 M8R	10	6.3	13	22	± 20	2.2	12	8	10	2.0
TCFG B 1A 336 M8R	10	6.3	13	33	± 20	3.3	14	10	12	1.9
TCFG B 1A 476 M8R	10	6.3	13	47	± 20	4.7	14	10	12	1.6
TCFG B 1A 107 M8R	10	6.3	13	100	± 20	20	40	20	30	1.5
TCFG B 1A 157 M8R	10	6.3	13	150	± 20	75	60	30	45	1.5
TCFG B 1C 335 M8R	16	10	20	3.3	± 20	0.5	10	6	8	4.2
TCFG B 1C 475 M8R	16	10	20	4.7	± 20	0.8	10	6	8	3.0
TCFG B 1C 106 M8R	16	10	20	10	± 20	1.6	10	6	8	2.5
TCFG B 1C 156 M8R	16	10	20	15	± 20	2.4	10	6	8	2.0
TCFG B 1C 226 M8R	16	10	20	22	± 20	3.5	10	6	8	1.9
TCFG B 1C 336 M8R	16	10	20	33	± 20	5.3	16	14	16	1.9
* TCFG B 1D 335 M8R	20	13	26	3.3	± 20	0.66	10	6	8	4.2
TCFG B 1D 475 M8R	20	13	26	4.7	± 20	1.0	10	6	8	3.0
* TCFG B 1D 106 M8R	20	13	26	10	± 20	2.0	12	8	10	15.0
TCFG B 1E 335 M8R	25	16	32	3.3	± 20	0.83	10	6	8	4.2
TCFG B 1E 475 M8R	25	16	32	4.7	± 20	1.2	10	6	8	3.0

* = Under development

Packaging specifications



•Reel dimensions



EIAJ ET-7200A

	Notes
1)	The information contained herein is subject to change without notice.
2)	Before you use our Products, please contact our sales representative and verify the latest specifica- tions :
3)	Although ROHM is continuously working to improve product reliability and quality, semicon- ductors can break down and malfunction due to various factors. Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.
4)	Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.
5)	The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.
6)	The Products are intended for use in general electronic equipment (i.e. AV/OA devices, communi- cation, consumer systems, gaming/entertainment sets) as well as the applications indicated in this document.
7)	The Products specified in this document are not designed to be radiation tolerant.
8)	For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative : transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.
9)	Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.
10)	ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.
11)	ROHM has used reasonable care to ensur the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.
12)	Please use the Products in accordance with any applicable environmental laws and regulations, such as the RoHS Directive. For more details, including RoHS compatibility, please contact a ROHM sales office. ROHM shall have no responsibility for any damages or losses resulting non-compliance with any applicable laws or regulations.
13)	When providing our Products and technologies contained in this document to other countries, you must abide by the procedures and provisions stipulated in all applicable export laws and regulations, including without limitation the US Export Administration Regulations and the Foreign Exchange and Foreign Trade Act.
14)	This document, in part or in whole, may not be reprinted or reproduced without prior consent of ROHM.



Thank you for your accessing to ROHM product informations. More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/